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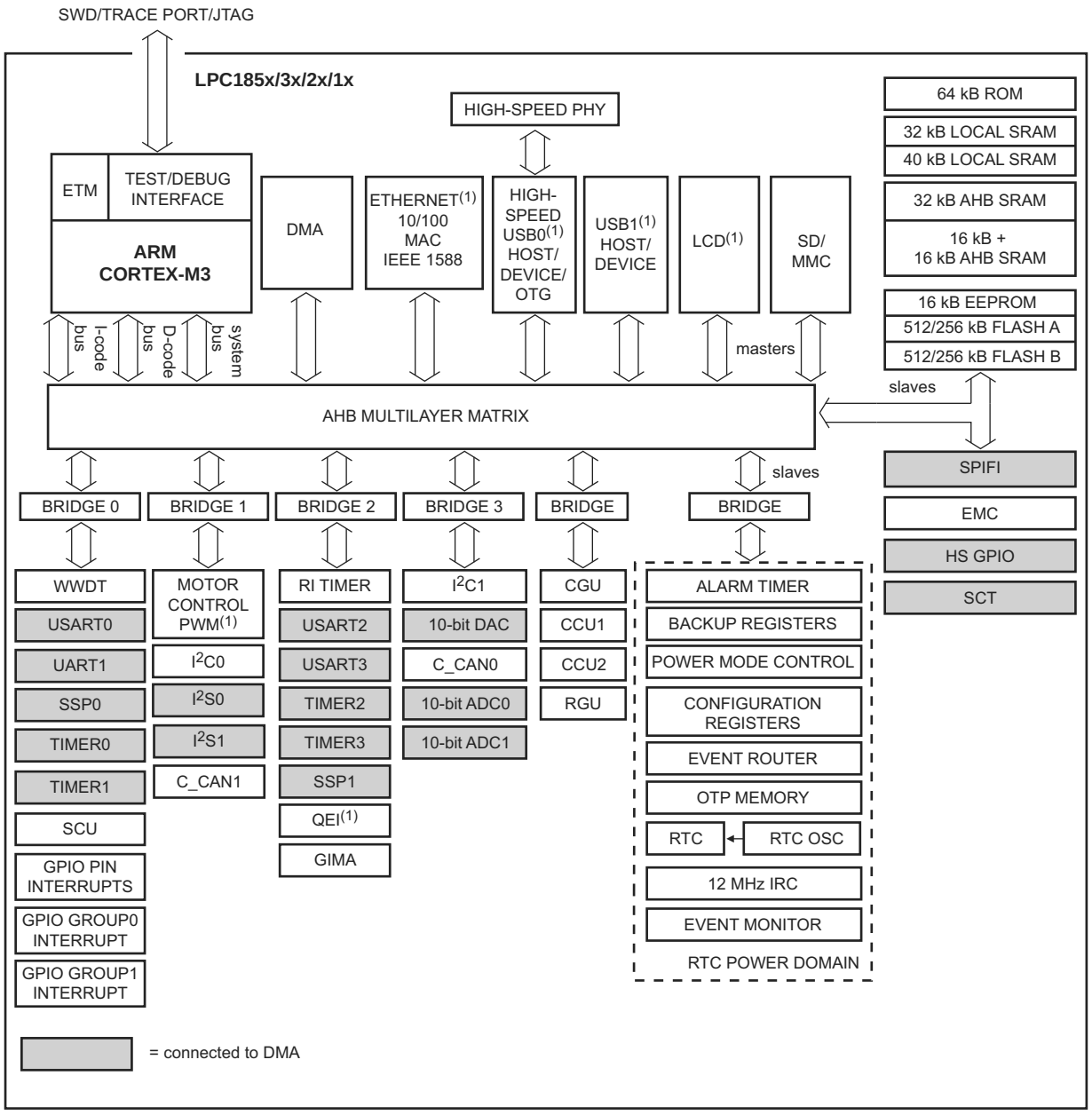
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M3
Core Size	32-Bit Single-Core
Speed	180MHz
Connectivity	CANbus, EBI/EMI, I²C, IrDA, Microwire, SD, SPI, SSI, SSP, UART/USART, USB, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, Motor Control PWM, POR, PWM, WDT
Number of I/O	83
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	16K x 8
RAM Size	136K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 8x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1827jbd144e

5. Block diagram



(1) Not available on all parts. See Table 2.

Fig 1. LPC185x/3x/2x/1x block diagram

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
P3_1	G11	F7	114	163	[2]	N; PU	I/O	**I2S0_TX_WS —** Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the *I²S-bus specification*.
							I/O	**I2S0_RX_WS —** Receive Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the *I²S-bus specification*.
							I	**CAN0_RD —** CAN receiver input.
							O	**USB1_IND1 —** USB1 Port indicator LED control output 1.
							I/O	**GPIO5[8] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							O	**LCD_VD15 —** LCD data.
							-	**R —** Function reserved.
P3_2	F11	G6	116	166	[2]	OL; PU	I/O	**I2S0_TX_SDA —** I²S transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the *I²S-bus specification*.
							I/O	**I2S0_RX_SDA —** I²S Receive data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the *I²S-bus specification*.
							O	**CAN0_TD —** CAN transmitter output.
							O	**USB1_IND0 —** USB1 Port indicator LED control output 0.
							I/O	**GPIO5[9] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							O	**LCD_VD14 —** LCD data.
							-	**R —** Function reserved.
P3_3	B14	A7	118	169	[4]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SSP0_SCK —** Serial clock for SSP0.
							O	**SPIFI_SCK —** Serial clock for SPIFI.
							O	**CGU_OUT1 —** CGU spare clock output 1.
							-	**R —** Function reserved.
							O	**I2S0_TX_MCLK —** I²S transmit master clock.
							I/O	**I2S1_TX_SCK —** Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the *I²S-bus specification*.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
P3_8	C10	E7	124	179	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SSP0_MOSI —** Master Out Slave in for SSP0.
							I/O	**SPIFI_CS —** SPIFI serial flash chip select.
							I/O	**GPIO5[11] —** General purpose digital input/output pin.
							I/O	**SSP0_SSEL —** Slave Select for SSP0.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P4_0	D5	-	1	1	[2]	N; PU	I/O	**GPIO2[0] —** General purpose digital input/output pin.
							O	**MCOA0 —** Motor control PWM channel 0, output A.
							I	**NMI —** External interrupt input to NMI.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**LCD_VD13 —** LCD data.
							I/O	**U3_UCLK —** Serial clock input/output for USART3 in synchronous mode.
							-	**R —** Function reserved.
P4_1	A1	-	3	3	[5]	N; PU	I/O	**GPIO2[1] —** General purpose digital input/output pin.
							O	**CTOUT_1 —** SCTimer/PWM output 1. Match output 3 of timer 3.
							O	**LCD_VD0 —** LCD data.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**LCD_VD19 —** LCD data.
							O	**U3_TXD —** Transmitter output for USART3.
							I	**ENET_COL —** Ethernet Collision detect (MII interface).
							AI	**ADC0_1 —** ADC0 and ADC1, input channel 1. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.
P4_2	D3	-	8	12	[2]	N; PU	I/O	**GPIO2[2] —** General purpose digital input/output pin.
							O	**CTOUT_0 —** SCTimer/PWM output 0. Match output 0 of timer 0.
							O	**LCD_VD3 —** LCD data.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**LCD_VD12 —** LCD data.
							I	**U3_RXD —** Receiver input for USART3.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
P4_3	C2	-	7	10	[5]	N; PU	I/O	**GPIO2[3] —** General purpose digital input/output pin.
							O	**CTOUT_3 —** SCTimer/PWM output 3. Match output 3 of timer 0.
							O	**LCD_VD2 —** LCD data.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**LCD_VD21 —** LCD data.
							I/O	**U3_BAUD —** Baud pin for USART3.
							-	**R —** Function reserved.
							AI	**ADC0_0 —** ADC0 and ADC1, input channel 0. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.
P4_4	B1	-	9	14	[5]	N; PU	I/O	**GPIO2[4] —** General purpose digital input/output pin.
							O	**CTOUT_2 —** SCTimer/PWM output 2. Match output 2 of timer 0.
							O	**LCD_VD1 —** LCD data.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**LCD_VD20 —** LCD data.
							I/O	**U3_DIR —** RS-485/EIA-485 output enable/direction control for USART3.
							-	**R —** Function reserved.
							AO	**DAC —** DAC output. Configure the pin as GPIO input and use the analog function select register in the SCU to select the DAC.
P4_5	D2	-	10	15	[2]	N; PU	I/O	**GPIO2[5] —** General purpose digital input/output pin.
							O	**CTOUT_5 —** SCTimer/PWM output 5. Match output 3 of timer 3.
							O	**LCD_FP —** Frame pulse (STN). Vertical synchronization pulse (TFT).
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
P4_10	M3	-	35	51	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_2 —** SCTimer/PWM input 2. Capture input 2 of timer 0.
							O	**LCD_VD10 —** LCD data.
							-	**R —** Function reserved.
							I/O	**GPIO5[14] —** General purpose digital input/output pin.
							O	**LCD_VD14 —** LCD data.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P5_0	N3	-	37	53	[2]	N; PU	I/O	**GPIO2[9] —** General purpose digital input/output pin.
							O	**MCOB2 —** Motor control PWM channel 2, output B.
							I/O	**EMC_D12 —** External memory data line 12.
							-	**R —** Function reserved.
							I	**U1_DSR —** Data Set Ready input for UART1.
							I	**T1_CAP0 —** Capture input 0 of timer 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P5_1	P3	-	39	55	[2]	N; PU	I/O	**GPIO2[10] —** General purpose digital input/output pin.
							I	**MCI2 —** Motor control PWM channel 2, input.
							I/O	**EMC_D13 —** External memory data line 13.
							-	**R —** Function reserved.
							O	**U1_DTR —** Data Terminal Ready output for UART1. Can also be configured to be an RS-485/EIA-485 output enable signal for UART1.
							I	**T1_CAP1 —** Capture input 1 of timer 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P5_2	R4	-	46	63	[2]	N; PU	I/O	**GPIO2[11] —** General purpose digital input/output pin.
							I	**MCI1 —** Motor control PWM channel 1, input.
							I/O	**EMC_D14 —** External memory data line 14.
							-	**R —** Function reserved.
							O	**U1_RTS —** Request to Send output for UART1. Can also be configured to be an RS-485/EIA-485 output enable signal for UART1.
							I	**T1_CAP2 —** Capture input 2 of timer 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
P6_3	P15	-	79	113	[2]	N; PU	I/O	**GPIO3[2] —** General purpose digital input/output pin.
							O	**USB0_PPWR —** VBUS drive signal (towards external charge pump or power management unit); indicates that VBUS must be driven (active HIGH). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the USB_PPWR used on other NXP LPC parts.
							-	**R —** Function reserved.
							O	**EMC_CS1 —** LOW active Chip Select 1 signal.
							-	**R —** Function reserved.
							I	**T2_CAP2 —** Capture input 2 of timer 2.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P6_4	R16	F6	80	114	[2]	N; PU	I/O	**GPIO3[3] —** General purpose digital input/output pin.
							I	**CTIN_6 —** SCTimer/PWM input 6. Capture input 1 of timer 3.
							O	**U0_TXD —** Transmitter output for USART0.
							O	**EMC_CAS —** LOW active SDRAM Column Address Strobe.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P6_5	P16	F9	82	117	[2]	N; PU	I/O	**GPIO3[4] —** General purpose digital input/output pin.
							O	**CTOUT_6 —** SCTimer/PWM output 6. Match output 2 of timer 1.
							I	**U0_RXD —** Receiver input for USART0.
							O	**EMC_RAS —** LOW active SDRAM Row Address Strobe.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P6_6	L14	-	83	119	[2]	N; PU	I/O	**GPIO0[5] —** General purpose digital input/output pin.
							O	**EMC_BLS1 —** LOW active Byte Lane select signal 1.
							-	**R —** Function reserved.
							I	**USB0_PWR_FAULT —** Port power fault signal indicating overcurrent condition; this signal monitors over-current on the USB bus (external circuitry required to detect over-current condition).
							-	**R —** Function reserved.
							I	**T2_CAP3 —** Capture input 3 of timer 2.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
P7_5	A7	-	133	191	[5]	N; PU	I/O	**GPIO3[13] —** General purpose digital input/output pin.
							O	**CTOUT_12 —** SCTimer/PWM output 12. Match output 3 of timer 3.
							-	**R —** Function reserved.
							O	**LCD_VD8 —** LCD data.
							O	**LCD_VD23 —** LCD data.
							O	**TRACEDATA[1] —** Trace data, bit 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							AI	**ADC0_3 —** ADC0 and ADC1, input channel 3. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.
P7_6	C7	-	134	194	[2]	N; PU	I/O	**GPIO3[14] —** General purpose digital input/output pin.
							O	**CTOUT_11 —** SCTimer/PWM output 1. Match output 3 of timer 2.
							-	**R —** Function reserved.
							O	**LCD_LP —** Line synchronization pulse (STN). Horizontal synchronization pulse (TFT).
							-	**R —** Function reserved.
							O	**TRACEDATA[2] —** Trace data, bit 2.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P7_7	B6	-	140	201	[5]	N; PU	I/O	**GPIO3[15] —** General purpose digital input/output pin.
							O	**CTOUT_8 —** SCTimer/PWM output 8. Match output 0 of timer 2.
							-	**R —** Function reserved.
							O	**LCD_PWR —** LCD panel power enable.
							-	**R —** Function reserved.
							O	**TRACEDATA[3] —** Trace data, bit 3.
							O	**ENET_MDC —** Ethernet MIIM clock.
							-	**R —** Function reserved.
							AI	**ADC1_6 —** ADC1 and ADC0, input channel 6. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
PC_7	G5	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							I/O	**USB1_ULPI_D1 —** ULPI link bidirectional data line 1.
							-	**R —** Function reserved.
							I	**ENET_RXD3 —** Ethernet receive data 3 (MII interface).
							I/O	**GPIO6[6] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							O	**T3_MAT0 —** Match output 0 of timer 3.
							I/O	**SD_DAT3 —** SD/MMC data bus line 3.
PC_8	N4	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							I/O	**USB1_ULPI_D0 —** ULPI link bidirectional data line 0.
							-	**R —** Function reserved.
							I	**ENET_RX_DV —** Ethernet Receive Data Valid (RMII/MII interface).
							I/O	**GPIO6[7] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							O	**T3_MAT1 —** Match output 1 of timer 3.
							I	**SD_CD —** SD/MMC card detect input.
PC_9	K2	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							I	**USB1_ULPI_NXT —** ULPI link NXT signal. Data flow control signal from the PHY.
							-	**R —** Function reserved.
							I	**ENET_RX_ER —** Ethernet receive error (MII interface).
							I/O	**GPIO6[8] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							O	**T3_MAT2 —** Match output 2 of timer 3.
							O	**SD_POW —** SD/MMC power monitor output.
PC_10	M5	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**USB1_ULPI_STP —** ULPI link STP signal. Asserted to end or interrupt transfers to the PHY.
							I	**U1_DSR —** Data Set Ready input for UART1.
							-	**R —** Function reserved.
							I/O	**GPIO6[9] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							O	**T3_MAT3 —** Match output 3 of timer 3.
							I/O	**SD_CMD —** SD/MMC command signal.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
PD_4	T2	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_8 —** SCTimer/PWM output 8. Match output 0 of timer 2.
							I/O	**EMC_D18 —** External memory data line 18.
							-	**R —** Function reserved.
							I/O	**GPIO6[18] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PD_5	P6	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_9 —** SCTimer/PWM output 9. Match output 3 of timer 3.
							I/O	**EMC_D19 —** External memory data line 19.
							-	**R —** Function reserved.
							I/O	**GPIO6[19] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PD_6	R6	-	-	68	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_10 —** SCTimer/PWM output 10. Match output 3 of timer 3.
							I/O	**EMC_D20 —** External memory data line 20.
							-	**R —** Function reserved.
							I/O	**GPIO6[20] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PD_7	T6	-	-	72	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_5 —** SCTimer/PWM input 5. Capture input 2 of timer 2.
							I/O	**EMC_D21 —** External memory data line 21.
							-	**R —** Function reserved.
							I/O	**GPIO6[21] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
PD_8	P8	-	-	74	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_6 —** SCTimer/PWM input 6. Capture input 1 of timer 3.
							I/O	**EMC_D22 —** External memory data line 22.
							-	**R —** Function reserved.
							I/O	**GPIO6[22] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PD_9	T11	-	-	84	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_13 —** SCTimer/PWM output 13. Match output 3 of timer 3.
							I/O	**EMC_D23 —** External memory data line 23.
							-	**R —** Function reserved.
							I/O	**GPIO6[23] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PD_10	P11	-	-	86	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_1 —** SCTimer/PWM input 1. Capture input 1 of timer 0. Capture input 1 of timer 2.
							O	**$\overline{\text{EMC\_BLS3}}$ —** LOW active Byte Lane select signal 3.
							-	**R —** Function reserved.
							I/O	**GPIO6[24] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PD_11	N9	-	-	88	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**$\overline{\text{EMC\_CS3}}$ —** LOW active Chip Select 3 signal.
							-	**R —** Function reserved.
							I/O	**GPIO6[25] —** General purpose digital input/output pin.
							I/O	**USB1_ULPI_D0 —** ULPI link bidirectional data line 0.
							O	**CTOUT_14 —** SCTimer/PWM output 14. Match output 2 of timer 3.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
PD_16	R14	-	-	104	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**EMC_A16 —** External memory address line 16.
							-	**R —** Function reserved.
							I/O	**GPIO6[30] —** General purpose digital input/output pin.
							O	**SD_VOLT2 —** SD/MMC bus voltage select output 2.
							O	**CTOUT_12 —** SCTimer/PWM output 12. Match output 3 of timer 3.
							-	**R —** Function reserved.
PE_0	P14	-	-	106	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**EMC_A18 —** External memory address line 18.
							I/O	**GPIO7[0] —** General purpose digital input/output pin.
							O	**CAN1_TD —** CAN1 transmitter output.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PE_1	N14	-	-	112	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**EMC_A19 —** External memory address line 19.
							I/O	**GPIO7[1] —** General purpose digital input/output pin.
							I	**CAN1_RD —** CAN1 receiver input.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PE_2	M14	-	-	115	[2]	N; PU	I	**ADCTRIG0 —** ADC trigger input 0.
							I	**CAN0_RD —** CAN receiver input.
							-	**R —** Function reserved.
							I/O	**EMC_A20 —** External memory address line 20.
							I/O	**GPIO7[2] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
PE_7	F15	-	-	149	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_5 —** SCTimer/PWM output 5. Match output 3 of timer 3.
							I	**U1_CTS —** Clear to Send input for UART1.
							I/O	**EMC_D26 —** External memory data line 26.
							I/O	**GPIO7[7] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PE_8	F14	-	-	150	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_4 —** SCTimer/PWM output 4. Match output 3 of timer 3.
							I	**U1_DSR —** Data Set Ready input for UART1.
							I/O	**EMC_D27 —** External memory data line 27.
							I/O	**GPIO7[8] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PE_9	E16	-	-	152	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_4 —** SCTimer/PWM input 4. Capture input 2 of timer 1.
							I	**U1_DCD —** Data Carrier Detect input for UART1.
							I/O	**EMC_D28 —** External memory data line 28.
							I/O	**GPIO7[9] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PE_10	E14	-	-	154	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_3 —** SCTimer/PWM input 3. Capture input 1 of timer 1.
							O	**U1_DTR —** Data Terminal Ready output for UART1. Can also be configured to be an RS-485/EIA-485 output enable signal for UART1.
							I/O	**EMC_D29 —** External memory data line 29.
							I/O	**GPIO7[10] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

Pin name	LBGA256	TFBGA100	LQFP144	LQFP208		Reset state [1]	Type	Description
Debug pins								
DBGEN	L4	A6	28	41	[2]	I	I	JTAG interface control signal. Also used for boundary scan. To use the part in functional mode, connect this pin in one of the following ways: • Leave DBGEN open. The DBGEN pin is pulled up internally by a 50 kΩ resistor. • Tie DBGEN to VDDIO. • Pull DBGEN up to VDDIO with an external pull-up resistor.
TCK/SWDCLK	J5	H2	27	38	[2]	I; F	I	Test Clock for JTAG interface (default) or Serial Wire (SW) clock.
$\overline{\text{TRST}}$	M4	B4	29	42	[2]	I; PU	I	Test Reset for JTAG interface.
TMS/SWDIO	K6	C4	30	44	[2]	I; PU	I	Test Mode Select for JTAG interface (default) or SW debug data input/output.
TDO/SWO	K5	H3	31	46	[2]	O	O	Test Data Out for JTAG interface (default) or SW trace output.
TDI	J4	G3	26	35	[2]	I; PU	I	Test Data In for JTAG interface.
USB0 pins								
USB0_DP	F2	E1	18	26	[6]	-	I/O	USB0 bidirectional D+ line. Do not add an external series resistor.
USB0_DM	G2	E2	20	28	[6]	-	I/O	USB0 bidirectional D− line. Do not add an external series resistor.
USB0_VBUS	F1	E3	21	29	[6] [7]	-	I	VBUS pin (power on USB cable). This pin includes an internal pull-down resistor of 70 kΩ (typical) ± 30 kΩ.
USB0_ID	H2	F1	22	30	[8]	-	I	Indicates to the transceiver whether connected as an A-device (USB0_ID LOW) or B-device (USB0_ID HIGH). For use with OTG, this pin has an internal pull-up resistor.
USB0_RREF	H1	F3	24	32	[8]	-		12.0 kΩ (accuracy 1 %) on-board resistor to ground for current reference.
USB1 pins								
USB1_DP	F12	E9	89	129	[9]	-	I/O	USB1 bidirectional D+ line. Add an external series resistor of 33 Ω +/- 2 %.
USB1_DM	G12	E10	90	130	[9]	-	I/O	USB1 bidirectional D− line. Add an external series resistor of 33 Ω +/- 2 %.
I^2C-bus pins								
I2C0_SCL	L15	D6	92	132	[10]	I; F	I/O	I^2C clock input/output. Open-drain output (for I^2C-bus compliance).
I2C0_SDA	L16	E6	93	133	[10]	I; F	I/O	I^2C data input/output. Open-drain output (for I^2C-bus compliance).
Reset and wake-up pins								
$\overline{\text{RESET}}$	D9	B6	128	185	[11]	I; IA	I	External reset input: A LOW on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. This pin does not have an internal pull-up.

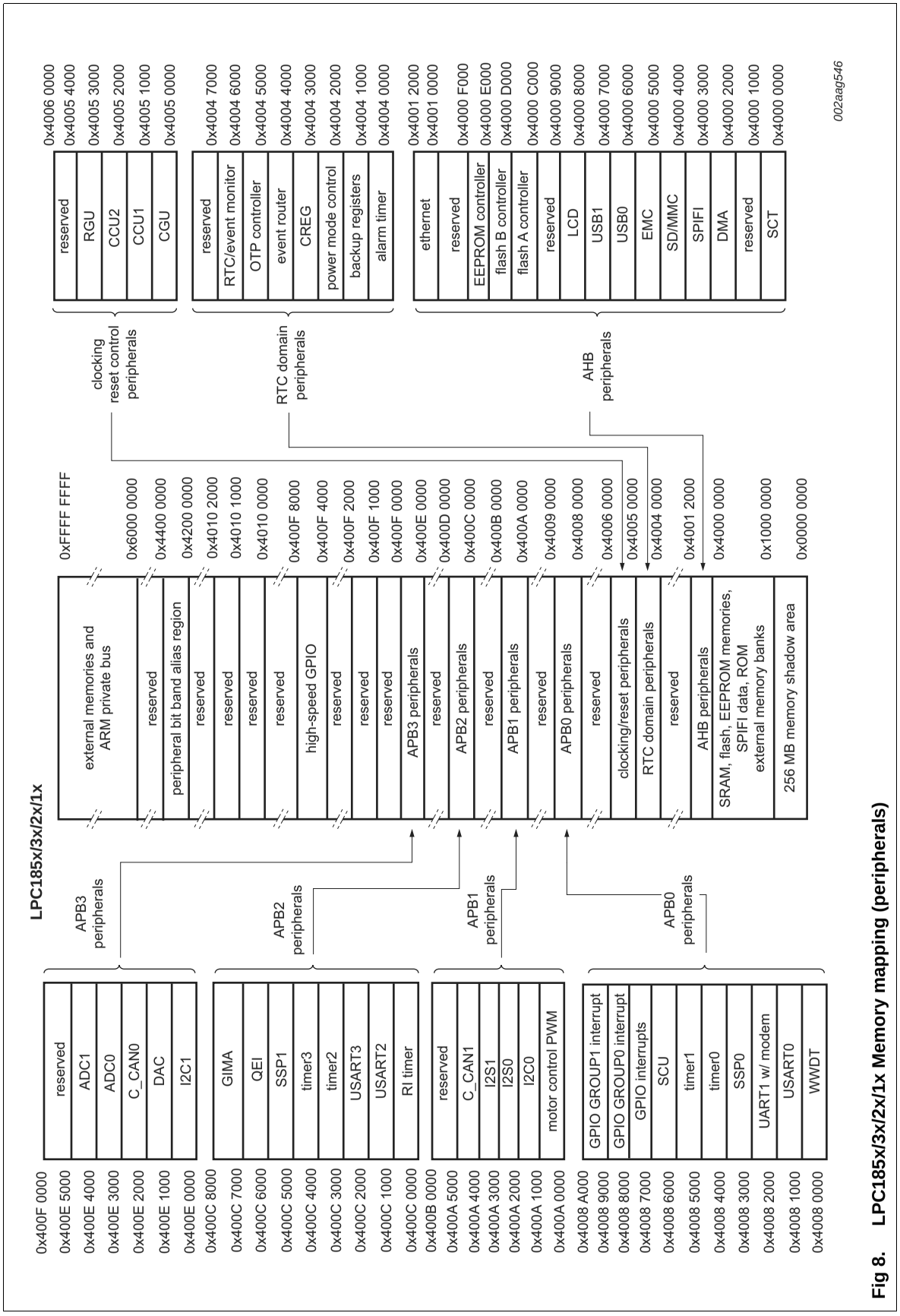


Fig 8. LPC185x/3x/2x/1x Memory mapping (peripherals)

- Timer/USART inputs
- Enabling the USB controllers

In addition, the CREG block contains the part identification and part configuration information.

7.20.2 System Control Unit (SCU)

The system control unit determines the function and electrical mode of the digital pins. By default function 0 is selected for all pins with pull-up enabled. For pins that support a digital and analog function, the ADC function select registers in the SCU enable the analog function.

A separate set of analog I/Os for the ADCs and the DAC as well as most USB pins are located on separate pads and are not controlled through the SCU.

In addition, the clock delay register for the SDRAM EMC_CLK pins and the registers that select the pin interrupts are located in the SCU.

7.20.3 Clock Generation Unit (CGU)

The Clock Generator Unit (CGU) generates several base clocks. The base clocks can be unrelated in frequency and phase and can have different clock sources within the CGU. One CGU base clock is routed to the CLKOUT pins. The base clock that generates the CPU clock is referred to as CCLK.

Multiple branch clocks are derived from each base clock. The branch clocks offer flexible control for power-management purposes. All branch clocks are outputs of one of two Clock Control Units (CCUs) and can be controlled independently. Branch clocks derived from the same base clock are synchronous in frequency and phase.

7.20.4 Internal RC oscillator (IRC)

The IRC is used as the clock source for the WWDT and/or as the clock that drives the PLLs and the CPU. The nominal IRC frequency is 12 MHz. The IRC is trimmed to 1.5 % accuracy for T_{amb} = 0 °C to 85 °C and 3% accuracy for T_{amb} = -40 °C to 0 °C and T_{amb} = 85 °C to 105 °C.

Upon power-up or any chip reset, the LPC185x/3x/2x/1x use the IRC as the clock source. The boot loader then configures the PLL1 to provide a 96 MHz clock for the core and the PLL0USB or PLL0AUDIO as needed if an external boot source is selected.

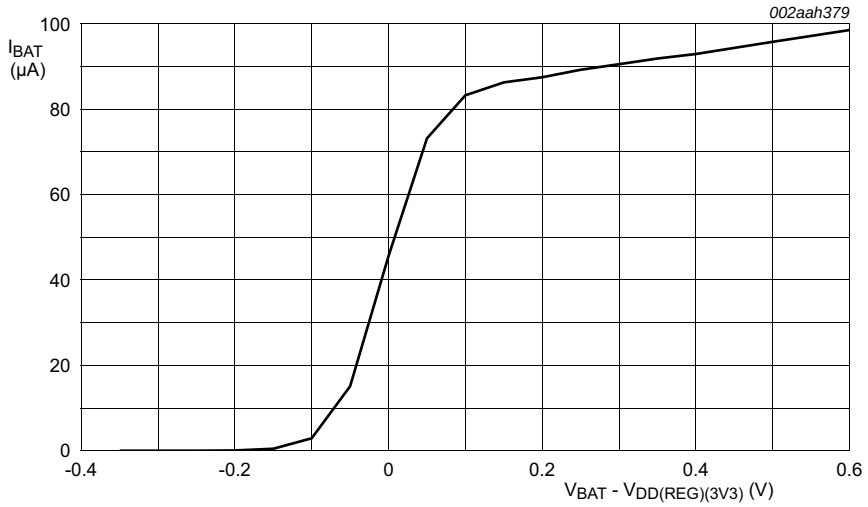
7.20.5 PLL0USB (for USB0)

PLL0 is a dedicated PLL for the USB0 High-speed controller.

PLL0 accepts an input clock frequency from an external oscillator in the range of 14 kHz to 25 MHz. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO). The CCO operates in the range of 4.3 MHz to 550 MHz.

7.20.6 PLL0AUDIO (for audio)

The audio PLL PLL0AUDIO is a general-purpose PLL with a small step size. This PLL accepts an input clock frequency derived from an external oscillator or internal IRC. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO). A sigma-delta converter modulates the PLL divider ratios to obtain the desired



Conditions: $V_{DD(REG)(3V3)}$ = 3.0 V; V_{BAT} = 2.6 V to 3.6 V; CCLK = 12 MHz.

Remark: The recommended operating condition for the battery supply is $V_{DD(REG)(3V3)} > V_{BAT} + 0.2$ V.

Fig 18. Typical battery supply current in Active mode

10.2 Peripheral power consumption

The typical power consumption at T = 25 °C for each individual peripheral is measured as follows:

1. Enable all branch clocks and measure the current $I_{DD(REG)(3V3)}$.
2. Disable the branch clock to the peripheral to be measured and keep all other branch clocks enabled.
3. Calculate the difference between measurement 1 and 2. The result is the peripheral power consumption.

Table 12. Peripheral power consumption

Peripheral	Branch clock	$I_{DD(REG)(3V3)}$ in mA	
		Branch clock frequency = 48 MHz	Branch clock frequency = 96 MHz
I2C1	CLK_APB3_I2C1	0.01	0.01
I2C0	CLK_APB1_I2C0	< 0.01	0.02
DAC	CLK_APB3_DAC	0.01	0.02
ADC0	CLK_APB3_ADC0	0.07	0.07
ADC1	CLK_APB3_ADC1	0.07	0.07
CAN0	CLK_APB3_CAN0	0.17	0.17
CAN1	CLK_APB1_CAN1	0.16	0.15
MOTOCON	CLK_APB1_MOTOCON	0.04	0.04
I2S	CLK_APB1_I2S	0.09	0.08
SPIFI	CLK_SPIFI, CLK_M3_SPIFI	1.14	2.29
GPIO	CLK_M3_GPIO	0.72	1.43

11. Dynamic characteristics

11.1 Flash/EEPROM memory

Table 15. Flash characteristics

T_{amb} = −40 °C to +105 °C, unless otherwise specified. $V_{DD(REG)(3V3)}$ = 2.4 V to 3.6 V for read operations; $V_{DD(REG)(3V3)}$ = 2.7 V to 3.6 V for erase/program operations.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
N_{endu}	endurance	sector erase/program	[1]	10000	-	-	cycles
		page erase/program; page in large sector		1000	-	-	cycles
		page erase/program; page in small sector		10000	-	-	cycles
t_{ret}	retention time	powered		10	-	-	years
		unpowered		10	-	-	years
t_{er}	erase time	page, sector, or multiple consecutive sectors		-	100	-	ms
t_{prog}	programming time		[2]	-	1	-	ms

[1] Number of erase/program cycles.

[2] Programming times are given for writing 512 bytes from RAM to the flash. Data must be written to the flash in blocks of 512 bytes.

Table 16. EEPROM characteristics

T_{amb} = −40 °C to +105 °C; $V_{DD(REG)(3V3)}$ = 2.7 V to 3.6 V.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
f_{clk}	clock frequency			800	1500	1600	kHz
N_{endu}	endurance			100 000	-	-	cycles
t_{ret}	retention time	T_{amb} = −40 °C to +85 °C		20	-	-	years
		85 °C < T_{amb} ≤ 105 °C		10	-	-	years
t_a	access time	read		-	120	-	ns
		erase/program; f_{clk} = 1500 kHz		-	1.99	-	ms
		erase/program; f_{clk} = 1600 kHz		-	1.87	-	ms
t_{wait}	wait time	read; RPHASE1	[1]	35	-	-	ns
		read; RPHASE2	[1]	70	-	-	ns
		write; PHASE1	[1]	20	-	-	ns
		write; PHASE2	[1]	40	-	-	ns
		write; PHASE3	[1]	10	-	-	ns

[1] See the LPC18xx user manual how to program the wait states for the different read (RPHASEx) and erase/program phases (PHASEx)

11.7 GPCLKIN

Table 22. Dynamic characteristic: GPCLKIN

T_{amb} = 25 °C; 2.4 V ≤ $V_{DD(REG)(3V3)}$ ≤ 3.6 V

Symbol	Parameter	Min	Typ	Max	Unit
GP_CLKIN	input frequency	-	-	25	MHz

11.8 I/O pins

Table 23. Dynamic characteristic: I/O pins[1]

T_{amb} = −40 °C to +105 °C; 2.7 V ≤ $V_{DD(IO)}$ ≤ 3.6 V.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Standard I/O pins - normal drive strength							
t_r	rise time	pin configured as output; EHS = 1	[2][3]	1.0	-	2.5	ns
t_f	fall time	pin configured as output; EHS = 1	[2][3]	0.9	-	2.5	ns
t_r	rise time	pin configured as output; EHS = 0	[2][3]	1.9	-	4.3	ns
t_f	fall time	pin configured as output; EHS = 0	[2][3]	1.9	-	4.0	ns
t_r	rise time	pin configured as input	[4]	0.3	-	1.3	ns
t_f	fall time	pin configured as input	[4]	0.2	-	1.2	ns
I/O pins - high drive strength							
t_r	rise time	pin configured as output; standard drive mode (EHD = 0x0)	[2][5]	4.3	-	7.9	ns
t_f	fall time	pin configured as output; standard drive mode (EHD = 0x0)	[2][5]	4.7	-	8.7	ns
t_r	rise time	pin configured as output; medium drive mode (EHD = 0x1)	[2][5]	3.2	-	5.7	ns
t_f	fall time	pin configured as output; medium drive mode (EHD = 0x1)	[2][5]	3.2	-	5.5	ns
t_r	rise time	pin configured as output; high drive mode (EHD = 0x2)	[2][5]	2.9	-	4.9	ns
t_f	fall time	pin configured as output; high drive mode (EHD = 0x2)	[2][5]	2.5	-	3.9	ns
t_r	rise time	pin configured as output; ultra-high drive mode (EHD = 0x3)	[2][5]	2.8	-	4.7	ns
t_f	fall time	pin configured as output; ultra-high drive mode (EHD = 0x3)	[2][5]	2.4	-	3.4	ns
t_r	rise time	pin configured as input	[4]	0.3	-	1.3	ns
t_f	fall time	pin configured as input	[4]	0.2	-	1.2	ns
I/O pins - high-speed							
t_r	rise time	pin configured as output; EHS = 1	[2][3]	350	-	670	ps
t_f	fall time	pin configured as output; EHS = 1	[2][3]	450	-	730	ps
t_r	rise time	pin configured as output; EHS = 0	[2][3]	1.0	-	1.9	ns
t_f	fall time	pin configured as output; EHS = 0	[2][3]	1.0	-	2.0	ns
t_r	rise time	pin configured as input	[4]	0.3	-	1.3	ns
t_f	fall time	pin configured as input	[4]	0.2	-	1.2	ns

[1] Simulated data.

Table 41. LCD panel connections for TFT panels

External pin	TFT 12 bit (4:4:4 mode)		TFT 16 bit (5:6:5 mode)		TFT 16 bit (1:5:5:5 mode)		TFT 24 bit	
	LPC18xx pin used	LCD function	LPC18xx pin used	LCD function	LPC18xx pin used	LCD function	LPC18xx pin used	LCD function
LCD_VD0	-	-	-	-	-	-	P4_1	RED0
LCD_LP	P7_6	LCDLP	P7_6	LCDLP	P7_6	LCDLP	P7_6	LCDLP
LCD_ENAB /LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM
LCD_FP	P4_5	LCDFP	P4_5	LCDFP	P4_5	LCDFP	P4_5	LCDFP
LCD_DCLK	P4_7	LCDDCLK	P4_7	LCDDCLK	P4_7	LCDDCLK	P4_7	LCDDCLK
LCD_LE	P7_0	LCDLE	P7_0	LCDLE	P7_0	LCDLE	P7_0	LCDLE
LCD_PWR	P7_7	LCDPWR	P7_7	LCDPWR	P7_7	LCDPWR	P7_7	LCDPWR
GP_CLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN

13.2 Crystal oscillator

The crystal oscillator is controlled by the XTAL_OSC_CTRL register in the CGU (see *LPC18xx user manual*).

The crystal oscillator operates at frequencies of 1 MHz to 25 MHz. This frequency can be boosted to a higher frequency, up to the maximum CPU operating frequency, by the PLL.

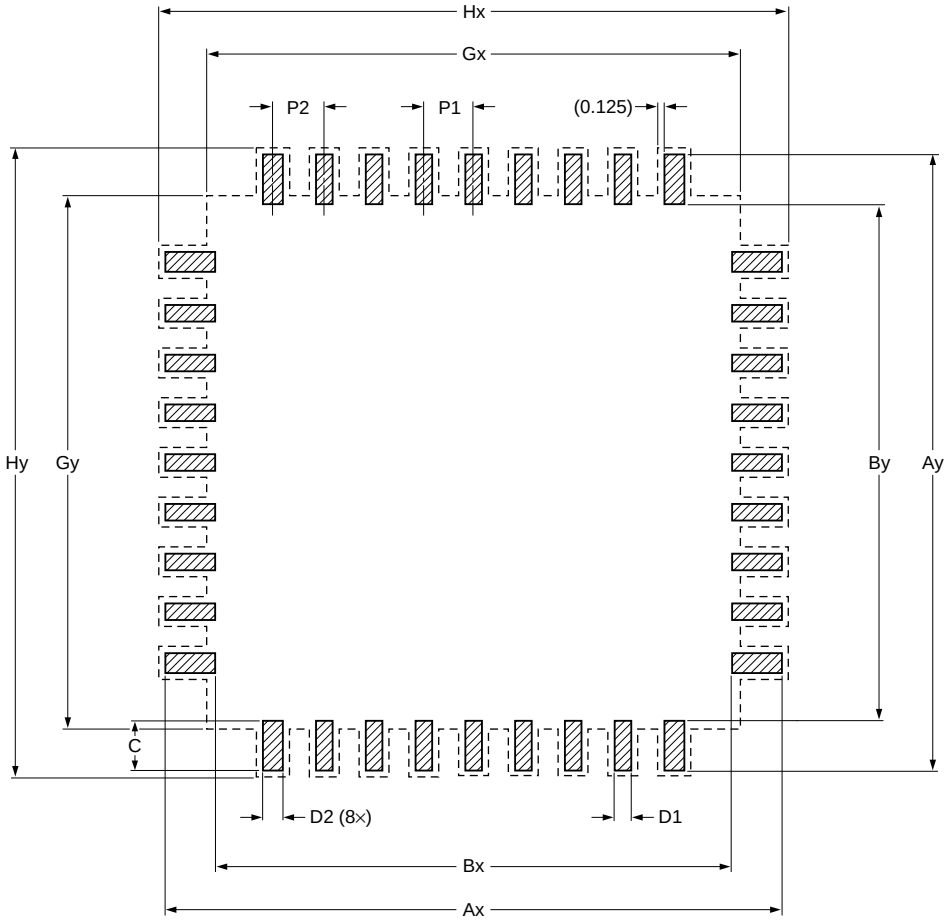
The oscillator can operate in one of two modes: slave mode and oscillation mode.

- In slave mode, couple the input clock signal with a capacitor of 100 pF (C_C in Figure 41), with an amplitude of at least 200 mV (RMS). The XTAL2 pin in this configuration can be left unconnected.
- External components and models used in oscillation mode are shown in Figure 42, and in Table 42 and Table 43. Since the feedback resistance is integrated on chip, only a crystal and the capacitances C_{X1} and C_{X2} need to be connected externally in case of fundamental mode oscillation (L, C_L and R_S represent the fundamental frequency). Capacitance C_P in Figure 42 represents the parallel package capacitance and must not be larger than 7 pF. Parameters F_C, C_L, R_S and C_P are supplied by the crystal manufacturer.

Table 42. Recommended values for $C_{X1/X2}$ in oscillation mode (crystal and external components parameters) low frequency mode

Fundamental oscillation frequency	Maximum crystal series resistance R_S	External load capacitors C_{X1}, C_{X2}
2 MHz	< 200 Ω	33 pF, 33 pF
	< 200 Ω	39 pF, 39 pF
	< 200 Ω	56 pF, 56 pF
4 MHz	< 200 Ω	18 pF, 18 pF
	< 200 Ω	39 pF, 39 pF
	< 200 Ω	56 pF, 56 pF
8 MHz	< 200 Ω	18 pF, 18 pF
	< 200 Ω	39 pF, 39 pF

Footprint information for reflow soldering of LQFP208 package **SOT459-1**



Generic footprint pattern

Refer to the package outline drawing for actual layout

solder land

occupied area

DIMENSIONS in mm

P1	P2	Ax	Ay	Bx	By	C	D1	D2	Gx	Gy	Hx	Hy
0.500	0.560	31.300	31.300	28.300	28.300	1.500	0.280	0.400	28.500	28.500	31.550	31.550

sot459-1_fr

Fig 55. Reflow soldering for the LQFP208 package